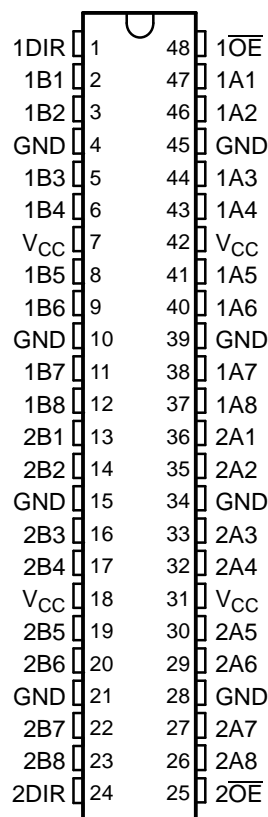


FEATURES

- Controlled Baseline
 - One Assembly/Test Site, One Fabrication Site
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree ⁽¹⁾
- Member of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Typical V_{OLP} (Output Ground Bounce) <1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (–32-mA I_{OH} , 64-mA I_{OL})
- Latch-Up Performance Exceeds 500 mA Per JESD 70
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)
- Shrink Small-Outline (DL) Package

- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

DL PACKAGE
(TOP VIEW)



DESCRIPTION/ORDERING INFORMATION

The SN74ABT16245A-EP is a 16-bit noninverting 3-state transceiver designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT16245A-EP is characterized for operation from -55°C to 125°C .



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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SN74ABT16245A-EP

16-BIT BUS TRANSCEIVER

WITH 3-STATE OUTPUTS

SCBS807B–OCTOBER 2005–REVISED JANUARY 2006

ORDERING INFORMATION

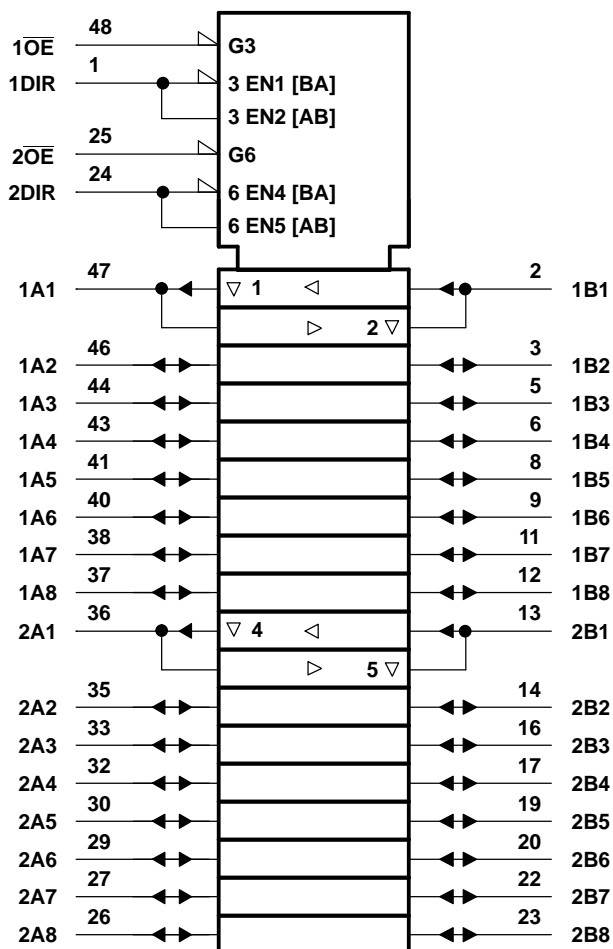
| T _A | PACKAGE ⁽¹⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------------------|--------------|-----------------------|------------------|
| –55°C to 125°C | SSOP – DL | Reel of 1000 | CABT16245AMDREP | ABT16245AMEP |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (EACH 8-BIT SECTION)

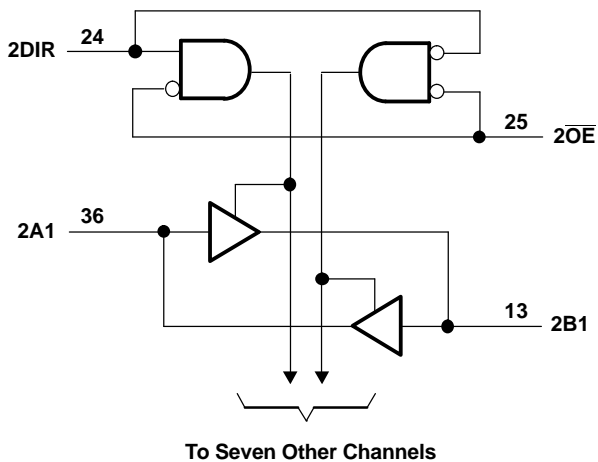
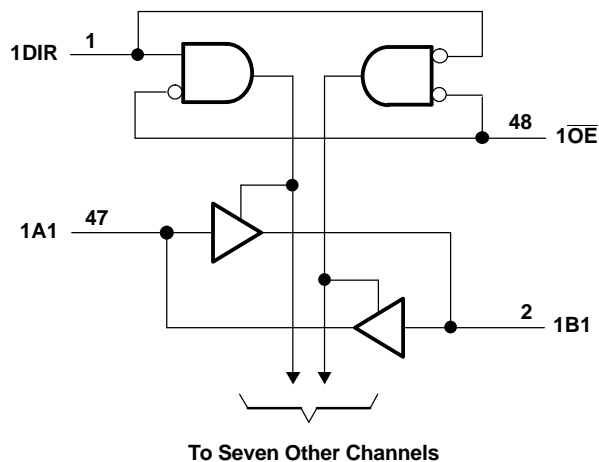
| INPUTS | | OPERATION |
|-----------------|-----|-----------------|
| \overline{OE} | DIR | |
| L | L | B data to A bus |
| L | H | A data to B bus |
| H | X | Isolation |

LOGIC SYMBOL⁽¹⁾



(1) This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | MIN | MAX | UNIT |
|---------------|--|-----------|-----|------|
| V_{CC} | Supply voltage range | -0.5 | 7 | V |
| V_I | Input voltage range (except I/O ports) ⁽²⁾ | -0.5 | 7 | V |
| V_O | Voltage range applied to any output in the high or power-off state | -0.5 | 5.5 | V |
| I_O | Current into any output in the low state | | 96 | mA |
| I_{IK} | Input clamp current | $V_I < 0$ | -18 | mA |
| I_{OK} | Output clamp current | $V_O < 0$ | -50 | mA |
| θ_{JA} | Package thermal impedance ⁽³⁾ | | 94 | °C/W |
| T_{stg} | Storage temperature range | -65 | 150 | °C |

- Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- The package thermal impedance is calculated in accordance with JESD 51.

Recommended Operating Conditions⁽¹⁾

| | | MIN | MAX | UNIT |
|--------------------------|------------------------------------|-----|----------|------|
| V_{CC} | Supply voltage | 4.5 | 5.5 | V |
| V_{IH} | High-level input voltage | 2 | | V |
| V_{IL} | Low-level input voltage | | 0.8 | V |
| V_I | Input voltage | 0 | V_{CC} | V |
| I_{OH} | High-level output current | | -24 | mA |
| I_{OL} | Low-level output current | | 48 | mA |
| $\Delta t/\Delta V$ | Input transition rise or fall rate | | 10 | ns/V |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate | 200 | | μs/V |
| T_A | Operating free-air temperature | -55 | 125 | °C |

- All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN74ABT16245A-EP

16-BIT BUS TRANSCEIVER

WITH 3-STATE OUTPUTS

SCBS807B–OCTOBER 2005–REVISED JANUARY 2006

Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | T _A = 25°C | | | MIN | MAX | UNIT |
|---------------------------------|----------------|--|-----------------------|--------------------|--------------------|-----|------|------|
| | | | MIN | TYP ⁽¹⁾ | MAX | | | |
| V _{IK} | | V _{CC} = 4.5 V, I _I = -18 mA | | | -1.2 | | -1.2 | V |
| V _{OH} | | V _{CC} = 4.5 V, I _{OH} = -3 mA | 2.5 | | | 2.5 | | V |
| | | V _{CC} = 5 V, I _{OH} = -3 mA | 3 | | | 3 | | |
| | | V _{CC} = 4.5 V | 2 | | | 2 | | |
| | | | 2 | | | | | |
| V _{OL} | | V _{CC} = 4.5 V | | | 0.55 | | 0.55 | V |
| | | | | | 0.55 | | | |
| V _{hys} | | | | 100 | | | | mV |
| I _I | Control inputs | V _{CC} = 0 to 5.5 V, V _I = V _{CC} or GND | | | ±1 | | ±1 | μA |
| | A or B port | V _{CC} = 2.1 V to 5.5 V, V _I = V _{CC} or GND | | | ±20 | | ±100 | |
| I _{OZPU} | | V _{CC} = 0 to 2.1 V, V _O = 0.5 V to 2.7 V, \overline{OE} = X | | | ±50 | | | μA |
| I _{OZPD} | | V _{CC} = 2.1 V to 0, V _O = 0.5 V to 2.7 V, \overline{OE} = X | | | ±50 | | | μA |
| I _{OZH} ⁽²⁾ | | V _{CC} = 2.7 V to 5.5 V, V _O = 2.7 V, \overline{OE} ≥ 2 V | | | 10 ⁽³⁾ | | 10 | μA |
| I _{OZL} ⁽²⁾ | | V _{CC} = 2.7 V to 5.5 V, V _O = 0.5 V, \overline{OE} ≥ 2 V | | | -10 ⁽³⁾ | | -10 | μA |
| I _{off} | | V _{CC} = 0, V _I or V _O ≤ 5.5 V | | | ±100 | | | μA |
| I _{CEX} | | V _{CC} = 5.5 V, V _O = 5.5 V | | | 50 | | 50 | μA |
| I _O ⁽⁴⁾ | | V _{CC} = 5.5 V, V _O = 2.5 V | -50 | -100 | -180 | -50 | -180 | mA |
| I _{CC} | A or B port | V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND | | | 2 | | 2 | mA |
| | | | | | 32 | | 32 | |
| | | | | | 2 | | 2 | |
| ΔI _{CC} ⁽⁵⁾ | Data inputs | V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND | | | 2 | | 1.5 | mA |
| | | | | | 0.05 | | 1 | |
| | Control inputs | V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND | | | 1.5 | | 1.5 | |
| C _i | Control inputs | V _I = 2.5 V or 0.5 V | | 3 | | | | pF |
| C _o | A or B port | V _O = 2.5 V or 0.5 V | | 6 | | | | pF |

(1) All typical values are at V_{CC} = 5 V.

(2) The parameters I_{OZH} and I_{OZL} include the input leakage current.

(3) This limit may vary among suppliers.

(4) Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

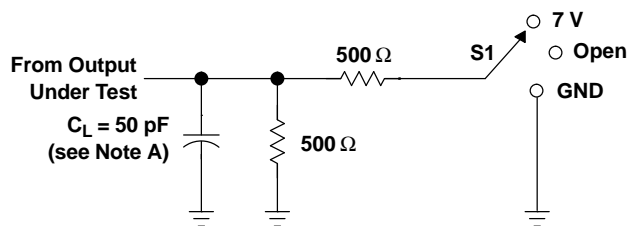
(5) This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V_{CC} or GND.

Switching Characteristics

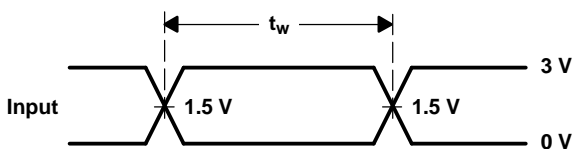
over recommended operating ranges of supply voltage and operating free-air temperature, $C_L = 50$ pF
(unless otherwise noted) (see [Figure 1](#))

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$ | | | MIN | MAX | UNIT |
|-----------|-----------------|----------------|---|-----|-----|-----|-----|------|
| | | | MIN | TYP | MAX | | | |
| t_{PLH} | A or B | B or A | 0.5 | 2.2 | 3.4 | 0.5 | 4 | ns |
| t_{PHL} | | | 0.5 | 2.3 | 3.8 | 0.5 | 4.6 | |
| t_{PZH} | \overline{OE} | B or A | 0.8 | 3.6 | 5.2 | 0.8 | 5.5 | ns |
| t_{PZL} | | | 0.9 | 3.7 | 6.1 | 0.1 | 7.3 | |
| t_{PHZ} | \overline{OE} | B or A | 1.3 | 4.4 | 5.8 | 1.3 | 6.3 | ns |
| t_{PLZ} | | | 1.4 | 3.3 | 4.7 | 1.4 | 5.5 | |

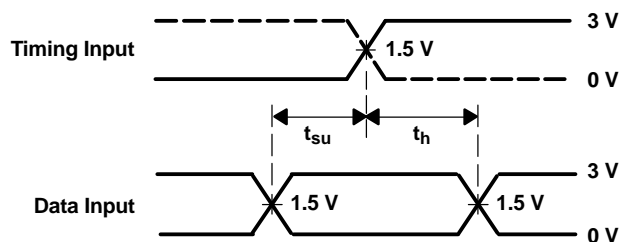
PARAMETER MEASUREMENT INFORMATION



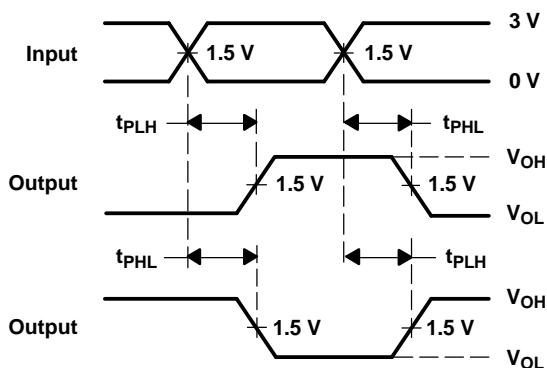
LOAD CIRCUIT



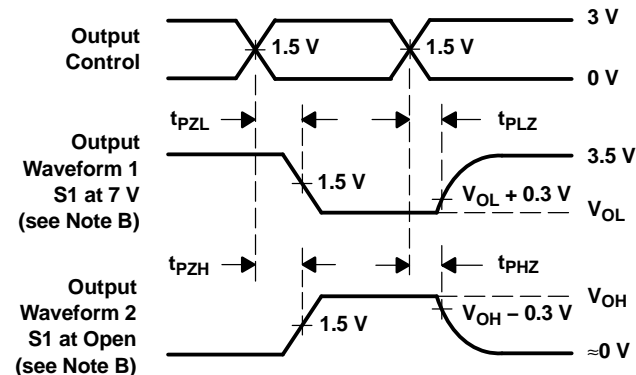
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



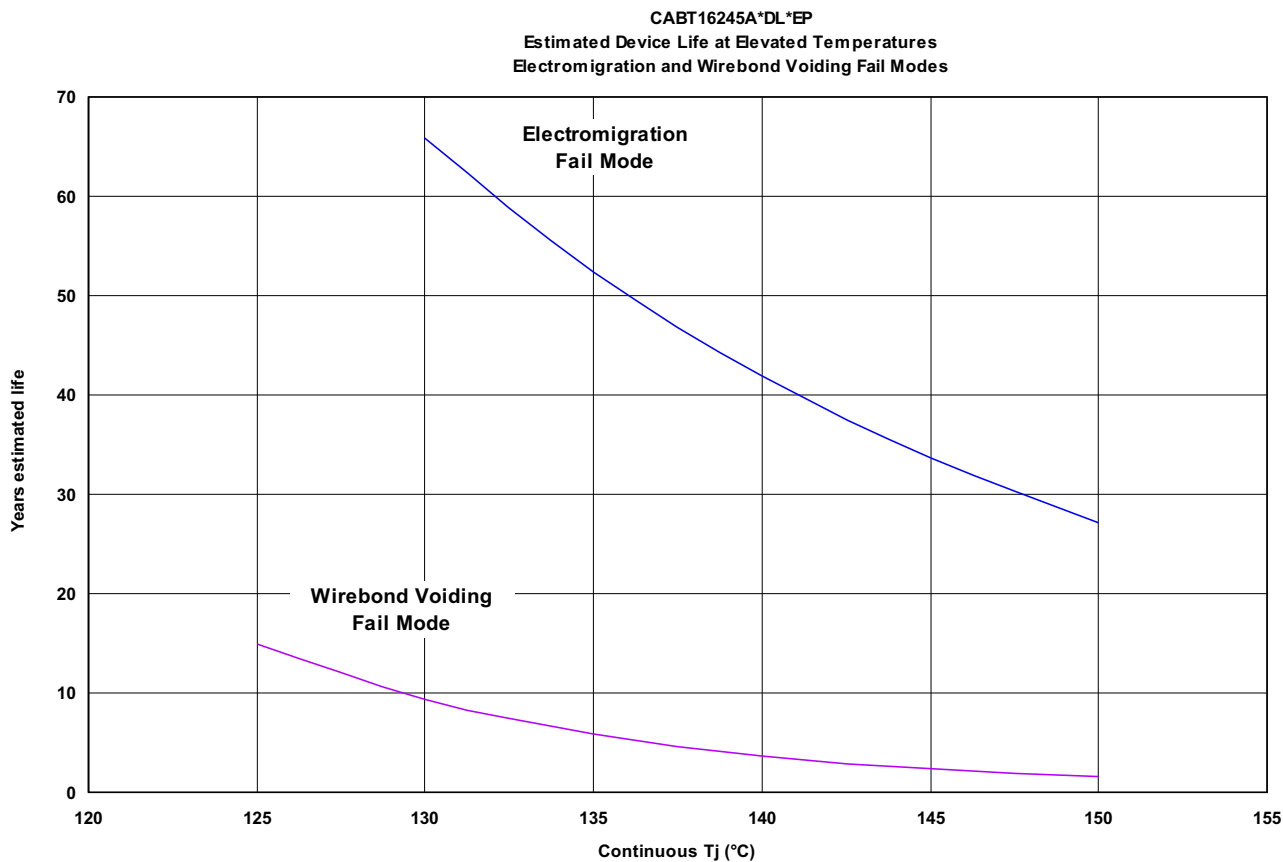
VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|---------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| CABT16245AMDLEP | Active | Production | SSOP (DL) 48 | 1000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | ABT16245AMEP |
| V62/06609-01XE | Active | Production | SSOP (DL) 48 | 1000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | ABT16245AMEP |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF SN74ABT16245A-EP :

- Catalog : [SN74ABT16245A](#)

- Military : [SN54ABT16245A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CABT16245AMDREP | SSOP | DL | 48 | 1000 | 330.0 | 32.4 | 11.35 | 16.2 | 3.1 | 16.0 | 32.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS

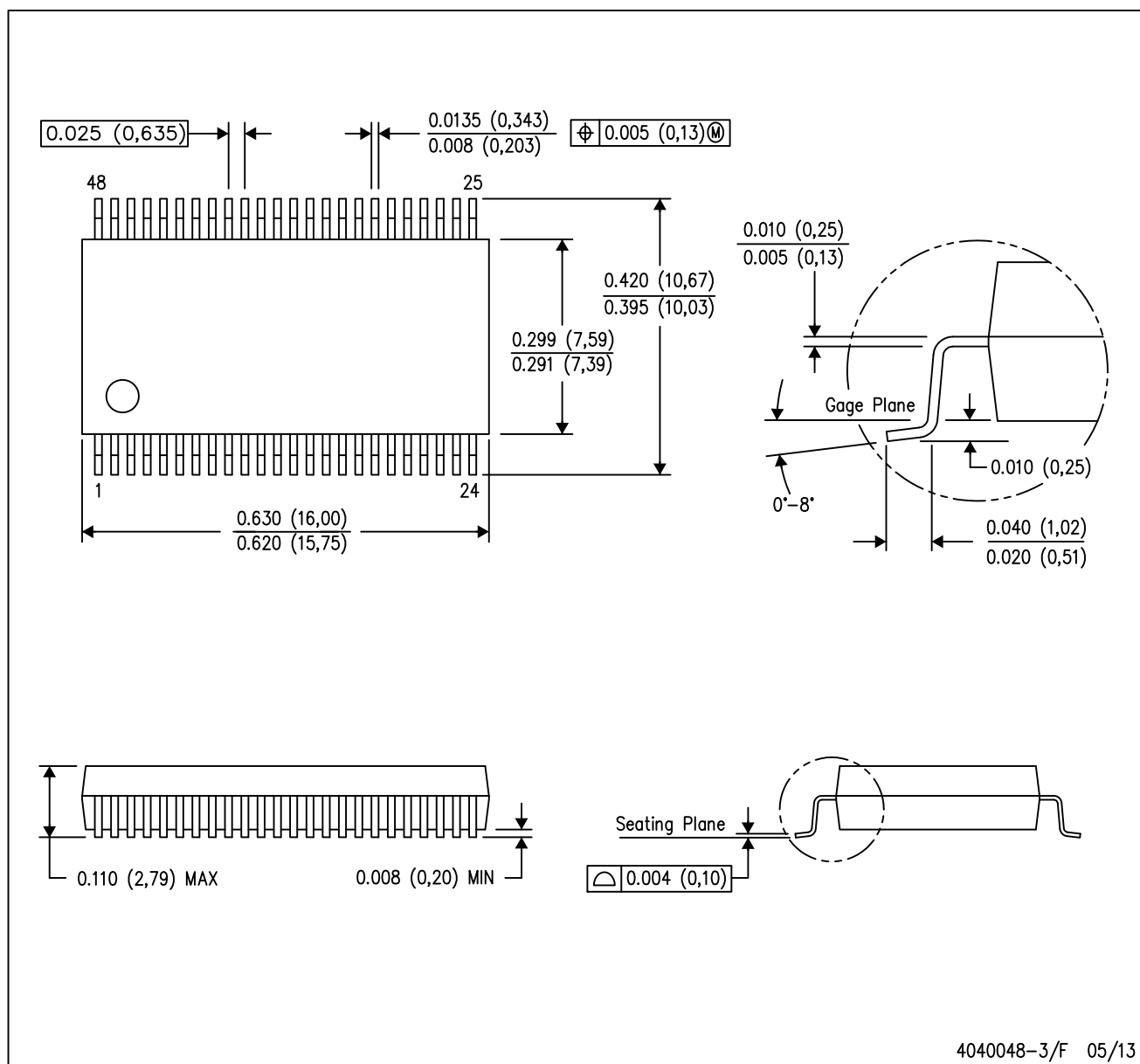


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CABT16245AMDREP | SSOP | DL | 48 | 1000 | 356.0 | 356.0 | 53.0 |

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MO-118

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